

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Takehito USHIKI et al.

Serial No: 10/016,008

Confirmation No.: 3846

Filed:

December 11, 2001

For:

SEMICONDUCTOR WAFER,

METHOD FOR PRODUCING THE

SAME, AND WAFER CHUCK

COMMENTS ON STATEMENT OF REASONS FOR ALLOWANCE

Mail Stop Issue Fee Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Art Unit: 1765

Examiner: Duy Vu Nguyen Deo

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop Issue Fee

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

March 3, 2004
Date of Deposit
Firoozeh Vakilzad

Signature Date

Applicant makes the following comments on the statement of reasons for allowance which is set forth in Paragraph 1 on page 2 of the Notice of Allowability dated January 23, 2004.

According to the statement, "Kao, doesn't describe determining ...". This should refer to "Kato" and not "Kao". U.S. Patent 5,447,890 of Kato et al. is the only reference applied in rejecting the claims in the prior Office Action. It is therefore apparent that the statement of reasons for allowance intended to refer to "Kato" and not "Kao". Applicant wishes to note this for the record.

Respectfully submitted,

HOGAN & HARTSON L.L.P.

Date: March 3, 2004

John P. Scherlacher

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Date of NOA: January 23, 2004

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Alexandria, VA 22313-1450, on

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Name

Signature

Firoozeh Vakilzadeh

Art Unit: 1765



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FOR PRODUCING THE SAME, AND

WAFER CHUCK

TRANSMITTAL OF ISSUE FEE

Mail Stop ISSUE FEE Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Notice of Allowance dated January 23, 2004, enclosed are the following:

- Form Part B Issue Fee Transmittal and a check in the amount of \$\,\bigs_1,636.00\) in payment of the Issue Fee, Publication Fee and Advance Order for \(\sigm_2\) patent copies (at \$3.00 per copy).
- Comments on Statement of Reasons for Allowance.

The Commissioner is hereby authorized to charge any deficiency in payment or credit any overpayment to Deposit Account No. 50-1314. A copy of this Transmittal is enclosed.

Respectfully submitted,

HOGAN & HARTSON L.L.P.

Date: March 3, 2004

John P. Scherlacher Registration No. 23,009

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